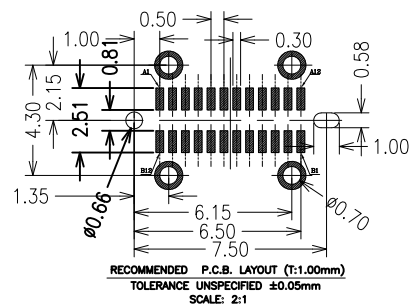
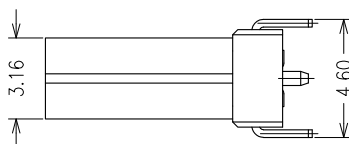
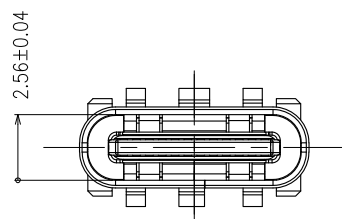
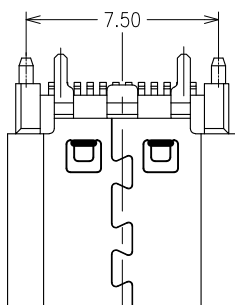
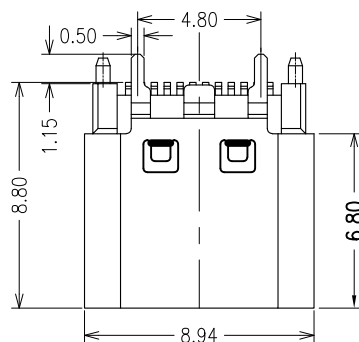
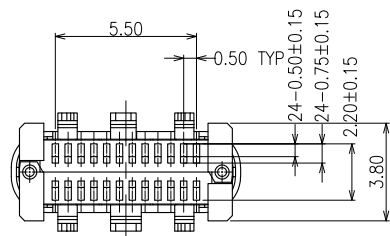




A1	GND	B12	GND
A2	SSTXP1	B11	SSRX1
A3	SSTXN1	B10	SSRXN1
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	DP1	B7	DN2
A7	DN1	B6	DP2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A10	SSRXN2	B3	SSTXN2
A11	SSRX1	B2	SSTX1
A12	GND	B1	GND
PIN	SIGNAL NAME	PIN	SIGNAL NAME

NOTES:

MOLDING: LCP UL94 V-0
 CONTACT: COPPER ALLOY.
 GOLD PLATING ALL OVER 50u" Min NICKEL
 AND 100u" Min Tin ALL OVER 50u" Min NICKEL
 ON SOLDER AREA
 SHELL: SUS304-H, T=0.30±0.03mm
 50u" NICKEL PLATING OVER ALL.
 SHILD: SUS304-H, T=0.12±0.03mm

INSERTION: 5~20N.
 EXTRACTION: 8~20N AFTER TEST .
 DURABILITY: 10000 CYCLES

3. ELECTRICAL:

CURRENT: 5A FOR VBUS;
 1.25A FOR GND PIN.
 0.25A FOR OTHER.

VOLTAGE: 20 V MAX
 WITHSTANDING VOLTAGE: 100V AC R.M.S
 CONTACT RESISTANCE: 40mΩ MAX.
 INSULATION RESISTANCE: 100MΩ MIN.

4. ENVIRONMENTAL

TEMPERATURE RANGE -55°C ~ +85°C



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X." ±2" X.X" ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: USB TYPE C 母座24P 立贴8.8H	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYCW709-USBC24-880B	MOLD NO.
UNIT: mm [inch] SCALE: 1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HYC-2605281204	SHEET NO. 1 OF 1